

March 2013

FQPF11P06

P-Channel QFET® MOSFET

-60 V, -8.6 A, 175 m Ω

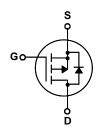
Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- -8.6 A, -60 V, $R_{DS(on)}$ =175 $m\Omega(Max.)$ @ V_{GS} =-10 V, I_{D} =-4.3 A
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 45 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQPF11P06	Unit	
V_{DSS}	Drain-Source Voltage		-60	V	
I _D	Drain Current - Continuous (T _C = 25°C) - Continuous (T _C = 100°C)		-8.6	А	
			-6.08	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-34.4	Α	
V _{GSS}	Gate-Source Voltage		± 25	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	160	mJ	
I _{AR}	Avalanche Current	(Note 1)	-8.6	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	3.0	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-7.0	V/ns	
P_D	Power Dissipation (T _C = 25°C)		30	W	
	- Derate above 25°C		0.2	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$		-60			V
ΔBV _{DSS} / ΔΤ _J	Breakdown Voltage Temperature Coefficient	I _D = -250 μA, Referenced	to 25°C		-0.07		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -60 V, V _{GS} = 0 V				-1	μА
		V _{DS} = -48 V, T _C = 150°C			-	-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = -25 \text{ V}, V_{DS} = 0 \text{ V}$			-	-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 25 V, V _{DS} = 0 V			1	100	nA
On Cha	aracteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, I_D = -4.3 \text{ A}$			0.14	0.175	Ω
9 _{FS}	Forward Transconductance	$V_{DS} = -30 \text{ V}, I_{D} = -4.3 \text{ A}$	(Note 4)		4.75		S
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			420 195	550 250	pF pF
C _{rss}	Reverse Transfer Capacitance				45	60	pF
Switchi	ing Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = -30 V, I _D = -5.7 A,			6.5	25	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$ (Note 4, 5)			40	90	ns
t _{d(off)}	Turn-Off Delay Time				15	40	ns
t _f	Turn-Off Fall Time				45	100	ns
Qg	Total Gate Charge	V _{DS} = -48 V, I _D = -11.4 A,			13	17	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V (Note 4, 5)			2.0		nC
Q _{gd}	Gate-Drain Charge				6.3		nC
Drain-S	Source Diode Characteristics ar	nd Maximum Ratings	;				
I _S	Maximum Continuous Drain-Source Diode Forward Current					-8.6	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	num Pulsed Drain-Source Diode Forward Current			1	-34.4	Α
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -8.6 \text{ A}$			I	-4.0	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = -11.4 \text{ A},$			83		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs	t t				μС

- Notes:
 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 2.5mH, I_{AS} = -8.6A, V_{DD} = -25V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} ≤ -11.4A, di/dt ≤ 300A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

Typical Characteristics

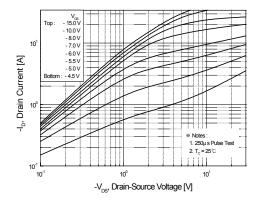


Figure 1. On-Region Characteristics

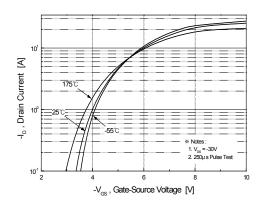


Figure 2. Transfer Characteristics

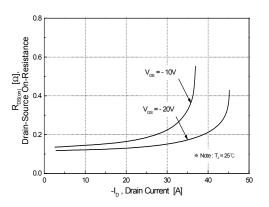


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

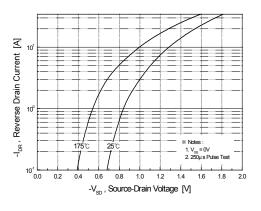


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

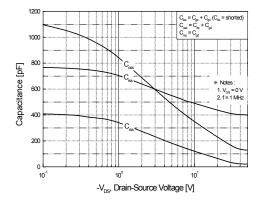


Figure 5. Capacitance Characteristics

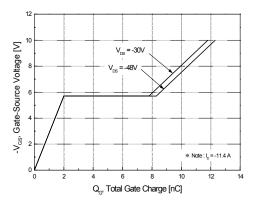
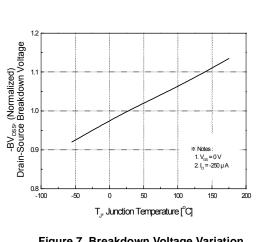


Figure 6. Gate Charge Characteristics



Typical Characteristics (Continued)

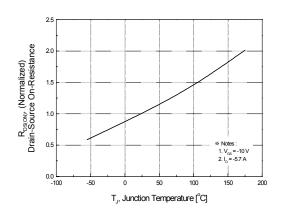
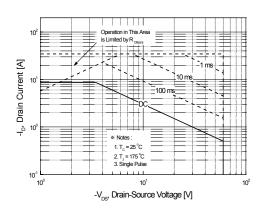


Figure 7. Breakdown Voltage Variation vs. Temperature

Figure 8. On-Resistance Variation vs. Temperature



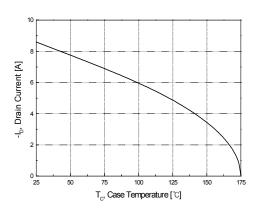


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

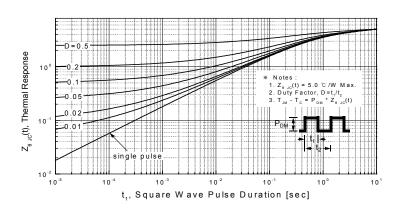
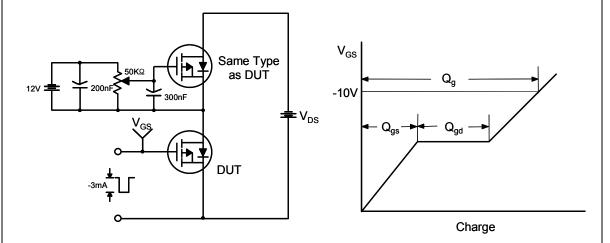
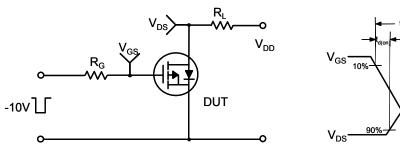


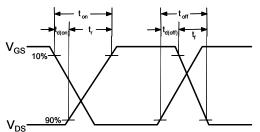
Figure 11. Transient Thermal Response Curve

Gate Charge Test Circuit & Waveform

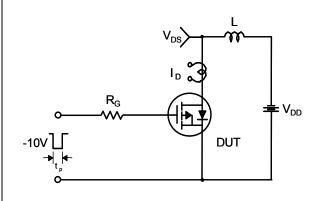


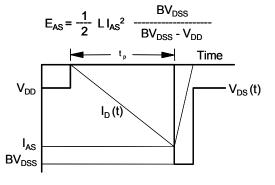
Resistive Switching Test Circuit & Waveforms



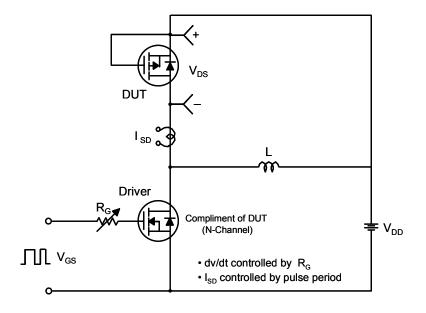


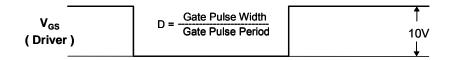
Unclamped Inductive Switching Test Circuit & Waveforms

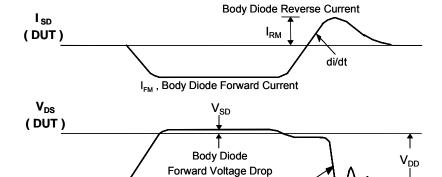




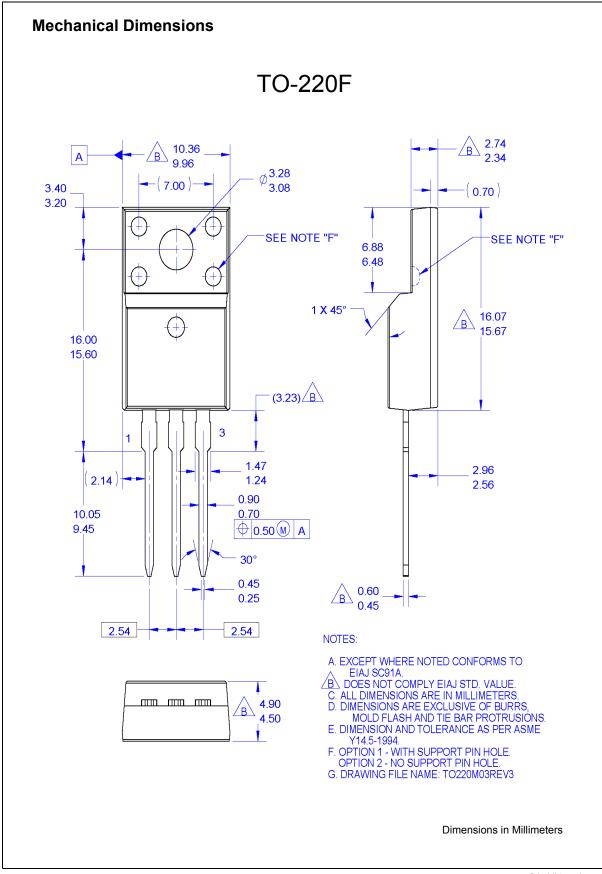
Peak Diode Recovery dv/dt Test Circuit & Waveforms







Body Diode Recovery dv/dt







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